

## SG901-1071 Miniature Wi-Fi Radio

#### Overview

The SG901-1071 WiFi module is optimized to simplify successful integration into systems requiring the latest performance with small size. This module is a highly integrated single chip based 802.11b/g/n WLAN radio for embedded, low-power and extremely small form factor mobile applications. The product conforms to the IEEE 802.11B, G, and N protocols operating in the 2.45GHz ISM frequency band supporting 802.11n modulations up to 72.2Mbps, all 802.11g OFDM modulations, and all mandatory 802.11b modulations.

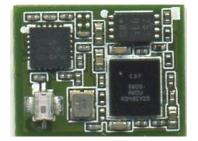
The SG901-1071 is a fully integrated wireless radio including RF Synthesizer/VCO, high-speed data converters, digital baseband processor, onboard MAC and PHY processors, Power Management, Power Amplifier, and LNA.

An on-board EEPROM stores calibration data for alignment-free integration. No customer calibration required.

Bluetooth integration features of the radio are made available.

An on-board crystal and filter simplify system integration. The addition of 1.8V, 3.3V, and VIHO supplies, Antenna, and host communication, provides a complete WiFi solution. For maximum flexibility, the SG901-1071 can be optionally supplied without internal oscillator and accept a wide range of external reference clock frequencies.

Host control is provided by either an SDIO or SPI interface.



### Features

- Very Small Footprint (12.0 x 9.5 x1.7mm)
- Factory Calibrated
- RoHs Compliant
- Fully Integrated 802.11 System Solution
- Ultra Low Current Consumption, 2.5 m A DITM = 1
- Fully Compliant with the IEEE 802.11B,G, and N
  WLAN Standards
- Support for 802.11n Modulations up to 72.2Mbps, and all 802.11g and Mandatory 802.11b Modulations
- Intelligent Power Control, Including 802.11 Power Save Mode
- Supports SPI Interface and SDIO Interface
- Factory Support for Linux 2.6/Android, Windows CE
- Source Code Available for porting to RTOS or Custom OS
- Hardware driver is provided under GPL
- Flexible I/O Voltage
- Contact Factory for FCC compliant applications

### Applications

- · Hand-held Devices
- Embedded Systems
- Portable Systems
- Point of Sale terminals
- Personal Digital Assistants (PDA)
- Cameras
- Cable Replacement

### **Ordering Information**

Packaging	Temp Range	Part Number
Tape and Reel	Extended	SG901-1071-ET-TR
Bulk	Extended	SG901-1071-ET-BLK
Tape and Reel	Commercial	SG901-1071-CT-TR
Bulk	Commercial	SG901-1071-CT-BLK

#### **Evaluation Kit Available**

This EVK supports embedded software development.

EVK for 1071

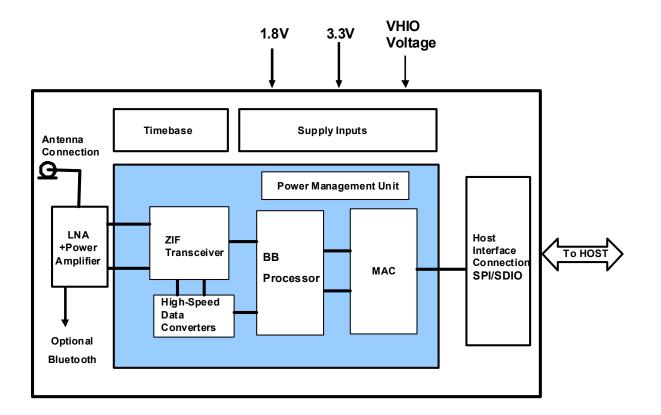
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# **Block Diagram**



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## **General Electrical Specifications**

Parameter		Test Condition / Comment	Min.	Тур.	Max.	Units
Absolute Maximum R	atings					
3.0V Supply			-0.3		3.6	V
VLDO Supply			-0.3		2.5	V
Operating Conditions	and Input Power Specifi	cations			- <b>I</b>	
Operating Temperature Range		ET Version (Extended Temperature)	-30		85	°C
		CT Version (Commercial Temperature)	0		70	°C
3.3V Supply	Input Supply Voltage	3.3V Supply input	2.7	3.3	3.6	V
	Standby Mode Current	32.768kHz Mode		270		uA
	Power Save Mode Current	DTIM = 1		2.5		mA
	Peak TX Current			270		mA
	Peak RX Current	Processing Beacons		82		mA
	Peak RX Current	Processing OFDM Packets		135		mA
Power Save Mode Settling Times	Wake up Time	From 32.768KHz Mode		5		mS
	Ramp up	To Processing Beacons		360		uS
	Ramp Down	To Stand By 32.768KHz mode		760		uS
VHIO Supply	Input Supply Voltage	VHIO input supply determines Host CMOS logic levels	s Host CMOS 1.7		3.3	V
	Input Supply Current	VHIO = 1.8V		1		mA
	Standby Mode Current	VHIO = 1.8V		100		uA
VLDO Supply	Input Supply Voltage	Required Internal regulator supply input	1.45		2.0	V
Input Voltage Levels	VIL		-0.3		0.25VHIO	V
	VIH		0.625VHIO		VHIO+0.3	V
Output Voltage Levels	VOL	IOL = 8.0mA			0.4	V
	VOH	IOH = -8.0mA	0.75VHIO		VHIO	V
Input Capacitance			1.0		5.0	pF

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## **RF Characteristics** (Max and Min based on temperature range)

Parameter		Test Condition / Comment	Min.	Тур.	Max.	Units
Antenna Port Impedance				50		Ohms
Antenna Input Return Loss		CH1 to CH14	-9.5		-14	dB
RX Sensitivity	11b, 1Mbps		-97	-96.3	-95	dBm
	11b, 2 Mbps		-94	-93.5	-91	dBm
	11b, 5.5 Mbps		-93	-91	-88	dBm
	11b, 11 Mbps		-89	-86.7	-85	dBm
	11g, 9Mbps		-92	-89.6	-88	dBm
	11g, 18Mbps		-87	-85.9	-84	dBm
	11g, 36Mbps		-80	-78.6	-77	dBm
	11g, 54Mbps		-74	-72.4	-70	dBm
	11n, MCS1			-86		dBm
	11n, MCS3			-80		dBm
	11n, MCS5			-72		dBm
	11n, MCS7			-69		dBm
Channel to Channel De-sensitivity	CH1 to 14	11g, 54Mbps 10% PER	-0.7		0.7	dB
Maximum Input Signal	CH7	11g, 54Mbps	-19		-16	dBm
	1Mbps			50		
	11Mbps			47		
Adjacent Channel	9Mbps			25		dB
Rejection	54Mbps			13		dB
	MCS1			24		dB
	MCS7			5		dB
					·	
TX Output Power	11b, 1Mbps	@202.11b anastral mask	15	16.5	19.1	dBm
	11b, 11Mbps	@802.11b spectral mask	15.5	16.2	19.4	dBm
	11g, 9Mbps	@802.11g spectral mask	17	18.2	19.5	dBm
	11g, 54Mbps	EVM = -27dB, 4.5%	11.7	13.4	15.1	dBm
	802.11n MCS1	@802.11n spectral mask		17		dBm
	802.11n MCS7	EVM = -27dB		13		dBm

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## **Pinout List**

SIGNAL NAME	PIN NUMBER	DESCRIPTION NOTES		NOTES		
Reference Clock Pins						
OSC_EN	4	Oscillator Enable Output		not normally used – Contact Sagrad for options		
REF_CLK	19	Reference Oscillator Input		normally not connected - Contact Sagrad for options		
RF Pins						
втн	13	Bluetooth RF Switched RF Connection		RF Connection for Input - Output		
2G4_RF	16	Wi-Fi / Bluetooth Antenna Port, 50 ohms		Careful RF design is needed for this and nearby ground		
Serial Interface Pins (VHIO Domain, logic levels compatible with the VHIO (Pin 32) input				the VHIO (Pin 32) input voltage)		
SDCMD	25	SPI MOSI (input)	SDIO CMD	VHIO Domain		
SDCLK	26	SPI Clock Input	SPI Clock Input SDIO CLK VHIO Domain			
SDD0	24	SPI MISO (output)	SDIO Data 0	VHIO Domain		
SDD1	23	SPI: Interrupt Output	SDIO Data 1	VHIO Domain		
SDD2	22		SDIO Data 2	VHIO Domain		
SDD3	21	SPI Chip Select Input	SDIO Data 3	VHIO Domain		
Control Pins						
POWERUP	5	Power Up Enable (from Host)		VLDO Domain with internal pull up High = operating, Low = off		
RSTn	31	Reset Input		VHIO Domain – Active Low reset		
SLEEPCLK	33	32.768 kHz Sleep Clock Input		VHIO Domain		
DBG_SPI_CSn	27	Debug SPI Chip Select Input		VHIO Domain		
DBG_SPI_CLK	30	Debug SPI Clock Input		VHIO Domain		
DBG_SPI_MISO	28	Debug SPI Data Output		VHIO Domain		
DBG_SPI_MOSI	29	Debug SPI Data Input		VHIO Domain		
Bluetooth Coexistence Pins (VHIO Domain)			omain)			
WLAN_DENY	1	Bluetooth Coexistence		VHIO Domain		
BT_ACTIVE	3	Bluetooth Coexistence		VHIO Domain		
BT_PERIODIC	2	Bluetooth Coexistence		VHIO Domain		
BT_STATUS	34	Bluetooth Coexistence		VHIO Domain		
Power and Ground Pins						
VHIO	32	Supply Voltage for I/O's		1.7 to 3.3V, Internally decoupled with a 0.1uF capacitor		
VLDO	6	External regulator supply input		1.45 to 2.0V, Internally decoupled with a 2.4uF capacito		
3.0V	8	RF supply		2.7 to 3.3V, Internally decoupled with a 0.2uF capacitor		
GND	7, 9, 10, 11, 12, 14, 15, 17, 18, 20, 35	Ground Connections				

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### Software Support

The 1071 and 1078 modules are supported through highly portable software. The hardware drivers and Wi-Fi stack as provided is compatible with Linux kernel 2.6. The source code for the hardware abstraction is available under a GPL license and is available from Sagrad. The licensed Wi-Fi licensed stack available from Sagrad is provided in binary form without a license. Source code for the Wi-Fi stack is available to the customer. To obtain source code for the stack contact Sagrad sales at <u>www.sagrad.com</u>. Software and source code are available free of charge but require a software license agreement for the Wi-Fi stack source.

In almost all cases the GPL driver will need to be modified for the customer's specific hardware. The Wi-Fi stack will only need to be modified for compatibility to the customers OS and compiler. In many cases such as Linux near zero modification of the Wi-Fi stack will be required.

The Wi-Fi module/stack currently is only tested in client mode and is compatible with any access point that meets 802.11 standards. An access point mode code base is planned in the future.

The complete 802.11 stack requires about 350KB of space for the implementation of the entire specification. Extremely small versions can be created by knowledgeable customers but is a considerable task and requires detailed understanding of 802.11.

As a service to customers, Sagrad offers extended technical support on a fee basis.

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Software Details:

SG901-1071

#### MAC

- Comprehensive MAC functionality according to IEEE 802.11-2007, including QoS traffic scheduling
- Supports the following optional IEEE 802.11n features:
- MPDU aggregation MSDU aggregation Immediate Block Acknowledgement PSMP MTBA RIFS L-SIG TXOP protection Link adaptation using MCS feedback

### Encryption

- Hardware encryption according to IEEE 802.11-2007 and IEEE 802.11w/D10.0: WEP40/64 WEP104/128 CCMP (AES) TKIP
  - BIP
- Hardware encryption support for SMS4 to supportWAPI
- Hardware encryption support for Cisco® CKIP

#### **OS Support:**

Windows Mobile 7 and 6.x, Windows CE 6.1 and 5, Linux v2.6, Android

### **Bluetooth Coexistence**

Feature	Linux		
Bluetooth Coexistence			
PTA (802.15.2)	Yes		
802.11/BT on same Antenna	Yes		
Data and Voice Simultaneously	Yes		
Data and Data Simultaneously	Yes		
Voice and Voice Simultaneously	Yes		

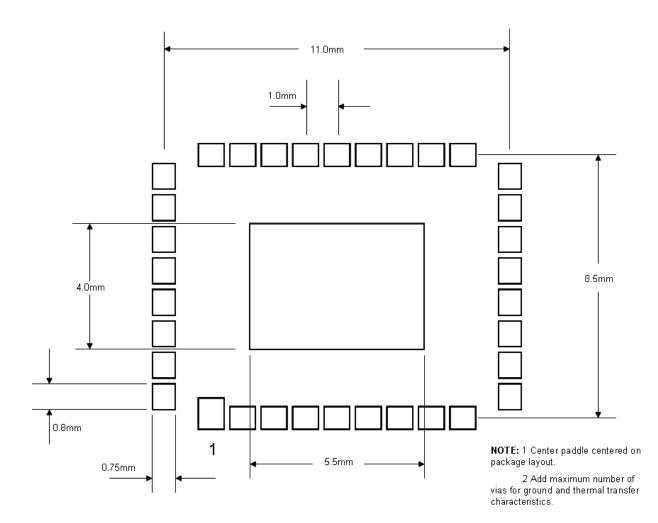
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### **Recommended Layout**

SG901-1071



PCB design requires detailed review of the center exposed pad. This pad requires good thermal conductivity. Soldering coverage should be maximized and checked via x-ray for proper design. There is a trade off in providing enough solder for conductivity, and too much which allows the module to "float" on the paddle creating reliability issues. Sagrad recommends two approaches, a large center via that allows excess soldering to flow down into the host PCB with smaller vias around it. Or many smaller vias with just enough space for the viscosity of the chosen solder/flux to allow some solder to flow into the smaller vias. Each of these approaches need to result in 60% or more full contact solder coverage on the paddle after reflow. Sagrad strongly encourages PCB layout teams to work with their EMS providers to insure vias and solder paste designs will result in satisfactory performance.

Note Pin one is on the bottom left of this diagram and is enlarged.

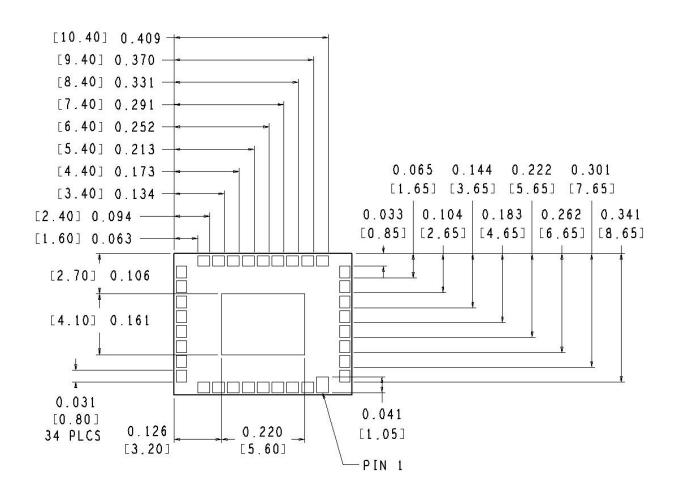
This view is viewed from the top.

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### **Mechanical**



The nominal size of the part is 10x13mm with a height of 1.7mm

### Packaging

The part comes packaged in Tape and Reel or bulk.

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